onsemi

MOSFET - Power, Single N-Channel

40 V, 9.0 mΩ, **41 A**

NVTFS5C471NL

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFS5C471NLWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	I _D	41	А
Current R _{θJC} (Notes 1, 2, 3, 4)		T _C = 100°C		27	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	30	W
$R_{\theta JC}$ (Notes 1, 2, 3)		$T_{C} = 100^{\circ}C$		15	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	Ι _D	12	А
Current R _{θJA} (Notes 1, 3, 4)		$T_A = 100^{\circ}C$		10	
Power Dissipation	State	T _A = 25°C	PD	3.0	W
$R_{\theta JA}$ (Notes 1, 3)		$T_A = 100^{\circ}C$		2.0	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	163	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	24	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.2 A)			E _{AS}	66	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 3)	$R_{\theta JC}$	5.2	°C/ W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	50	vv

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

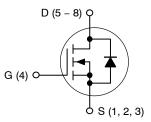
2. Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

 Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
40 V	9.0 mΩ @ 10 V	41 A
40 V	15.5 mΩ @ 4.5 V	41 A

N-Channel

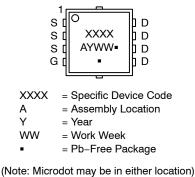




WDFN8 (µ8FL) CASE 511AB

WDFNW8 (µ8FL WF) CASE 515AN





ORDERING INFORMATION

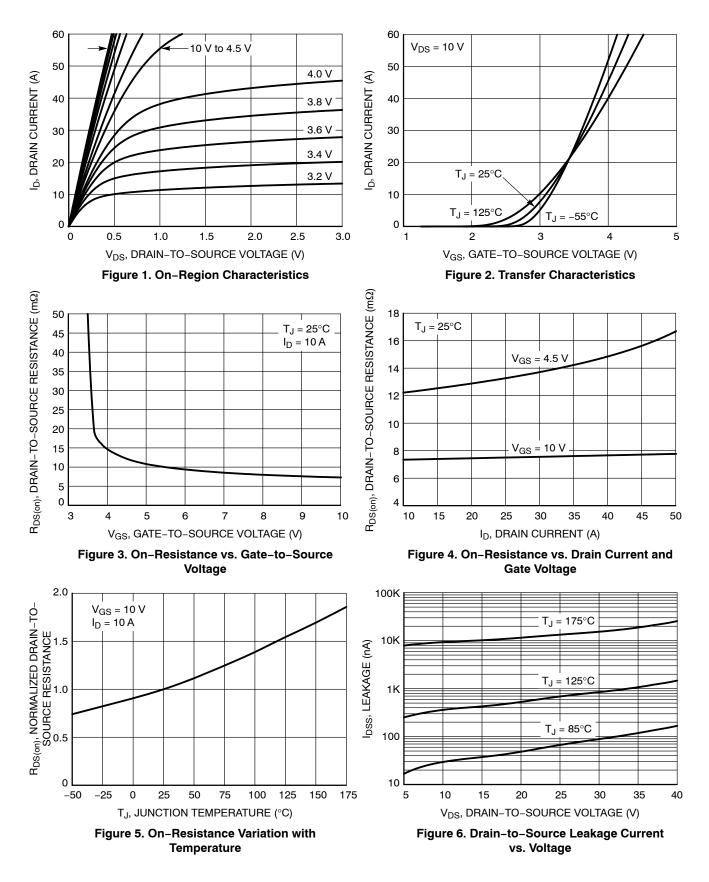
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

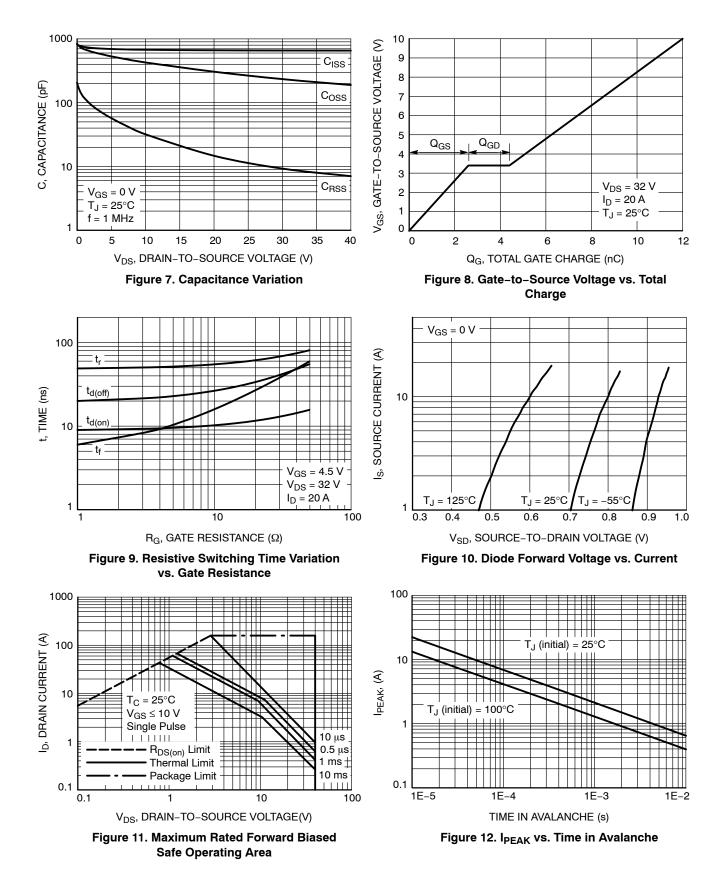
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		40			V
Zero Gate Voltage Drain Current	I _{DSS}	$v_{GS} = 0 v,$	$T_J = 25^{\circ}C$			10	μΑ
			T _J = 125°C			250	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{DS}$	= 20 μA	1.2		2.2	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A			7.4	9.0	mΩ
		V _{GS} = 4.5 V, I	V _{GS} = 4.5 V, I _D = 10 A		12.3	15.5	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I	_D = 20 A		36		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}				660		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = V _{DS} = 2			270		1
Reverse Transfer Capacitance	C _{rss}	$v_{DS} = 20 v$			12		1
Total Gate Charge	Q _{G(TOT)}				5.5		nC
Threshold Gate Charge	Q _{G(TH)}				1.4		nC
Gate-to-Source Charge	Q _{GS}	V_{GS} = 4.5 V, V_{DS} = 32 V, I_D = 20 A V_{GS} = 10 V, V_{DS} = 32 V, I_D = 20 A			2.6		
Gate-to-Drain Charge	Q _{GD}				1.8		
Total Gate Charge	Q _{G(TOT)}				12		nC
SWITCHING CHARACTERISTICS (No	te 6)	-					
Turn-On Delay Time	t _{d(on)}				9.0		ns
Rise Time	t _r	V _{GS} = 4.5 V. Vr	ns = 32 V.		49		
Turn-Off Delay Time	t _{d(off)}	$\begin{array}{l} V_{GS} = 4.5 \; V, \; V_{DS} = 32 \; V, \\ I_{D} = 20 \; A, \; R_{G} = 1.0 \; \Omega \end{array}$			20		
Fall Time	t _f				6		
DRAIN-SOURCE DIODE CHARACTER	ISTICS	-					
Forward Diode Voltage	V _{SD}	ls = 10 A	$T_J = 25^{\circ}C$		0.8	1.2	V
			T _J = 125°C		0.7		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dl _S /dt = 100 A/µs, I _S = 20 A			23		ns
Charge Time	t _a				11		
Discharge Time	t _b				11		
Reverse Recovery Charge	Q _{RR}				10		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

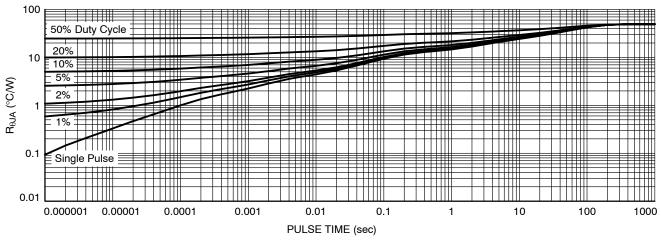


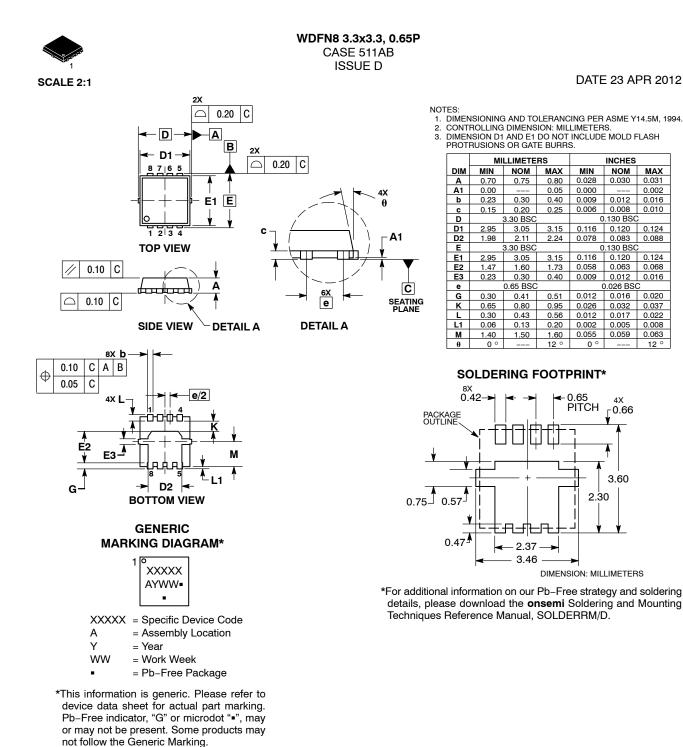
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVTFS5C471NLTAG	471L	WDFN8 (Pb-Free)	1500 / Tape & Reel
NVTFS5C471NLWFTAG	71LW	WDFNW8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





 DOCUMENT NUMBER:
 98AON30561E
 Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

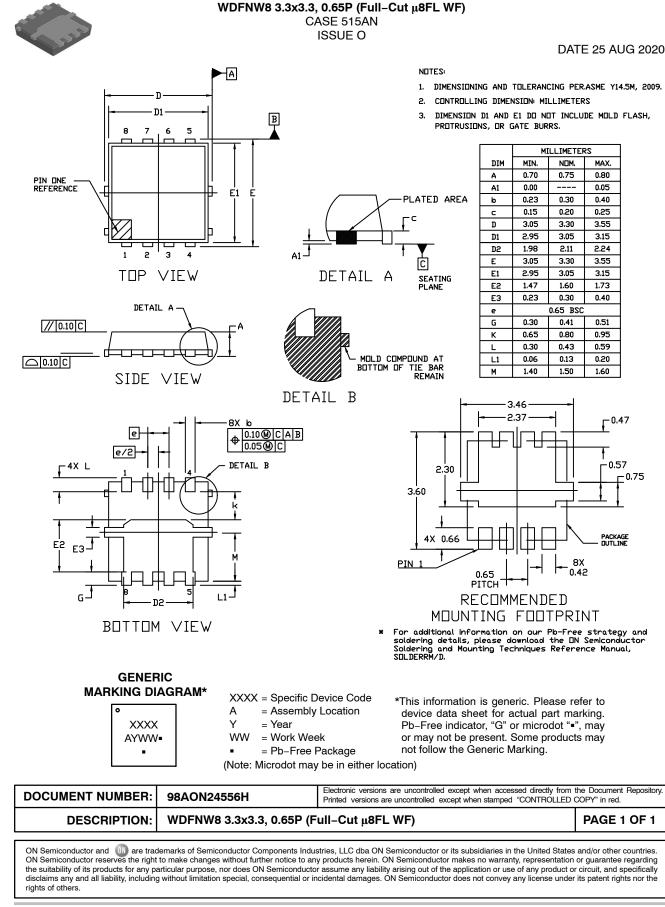
 DESCRIPTION:
 WDFN8 3.3X3.3, 0.65P
 PAGE 1 OF 1

 onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019





© Semiconductor Components Industries, LLC, 2018

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>